

SSM3K16FV

High Speed Switching Applications

Analog Switch Applications

- Suitable for high-density mounting due to compact package
- Low on-resistance : $R_{on} = 3.0 \Omega$ (max) (@ $V_{GS} = 4 \text{ V}$)
: $R_{on} = 4.0 \Omega$ (max) (@ $V_{GS} = 2.5 \text{ V}$)
: $R_{on} = 15 \Omega$ (max) (@ $V_{GS} = 1.5 \text{ V}$)

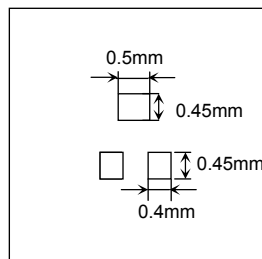
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V_{DS}	20	V
Gate-Source voltage		V_{GS}	± 10	V
Drain current	DC	I_D	100	mA
	Pulse	I_{DP}	200	
Drain power dissipation ($T_a = 25^\circ\text{C}$)		P_D (Note 1)	150	mW
Channel temperature		T_{ch}	150	$^\circ\text{C}$
Storage temperature		T_{stg}	-55 to 150	$^\circ\text{C}$

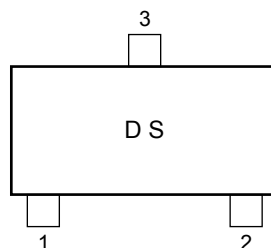
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

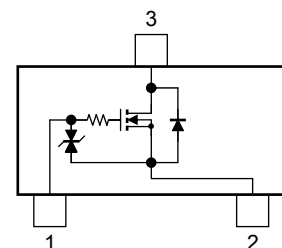
Note 1: Total rating, mounted on FR4 board (25.4 mm × 25.4 mm × 1.6 t)



Marking



Equivalent Circuit



nit: mm

<p>Top view dimensions: 1.2±0.05 (width), 0.8±0.05 (width of central pad), 0.22±0.05 (height of central pad), 0.4 (width of central pad), 0.4 (height of central pad), 0.32±0.05 (height of central pad), 0.5±0.05 (height of central pad), 0.13±0.05 (height of central pad). Side view dimensions: 0.5±0.05 (height of central pad), 0.13±0.05 (height of central pad).</p> <p>1. Gate 2. Source 3. Drain</p>	
JEDEC	-
JEITA	-
TOSHIBA	2-1L1B

Weight: 0.0015 g (typ.)

Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

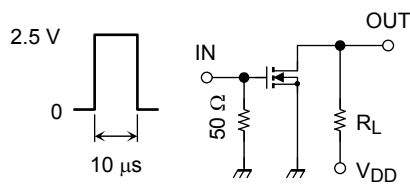
Start of commercial production
2003-04

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 10\text{ V}$, $V_{DS} = 0$	—	—	± 1	μA
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = 0.1\text{ mA}$, $V_{GS} = 0$	20	—	—	V
Drain cut-off current	I_{DSS}	$V_{DS} = 20\text{ V}$, $V_{GS} = 0$	—	—	1	μA
Gate threshold voltage	V_{th}	$V_{DS} = 3\text{ V}$, $I_D = 0.1\text{ mA}$	0.6	—	1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3\text{ V}$, $I_D = 10\text{ mA}$	40	—	—	mS
Drain-Source on-resistance	$R_{DS(ON)}$	$I_D = 10\text{ mA}$, $V_{GS} = 4\text{ V}$	—	1.5	3.0	Ω
		$I_D = 10\text{ mA}$, $V_{GS} = 2.5\text{ V}$	—	2.2	4.0	
		$I_D = 1\text{ mA}$, $V_{GS} = 1.5\text{ V}$	—	5.2	15	
Input capacitance	C_{iss}	$V_{DS} = 3\text{ V}$, $V_{GS} = 0$, $f = 1\text{ MHz}$	—	9.3	—	pF
Reverse transfer capacitance	C_{rss}	$V_{DS} = 3\text{ V}$, $V_{GS} = 0$, $f = 1\text{ MHz}$	—	4.5	—	pF
Output capacitance	C_{oss}	$V_{DS} = 3\text{ V}$, $V_{GS} = 0$, $f = 1\text{ MHz}$	—	9.8	—	pF
Switching time	Turn-on time	$V_{DD} = 3\text{ V}$, $I_D = 10\text{ mA}$, $V_{GS} = 0\text{ to }2.5\text{ V}$	—	70	—	ns
	Turn-off time		—	125	—	

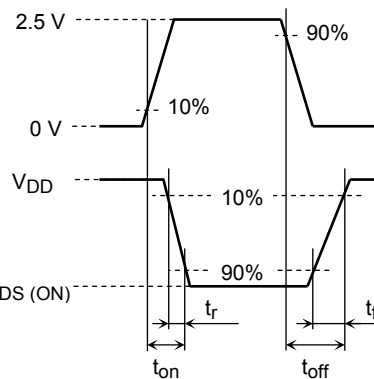
Switching Time Test Circuit

(a) Test circuit

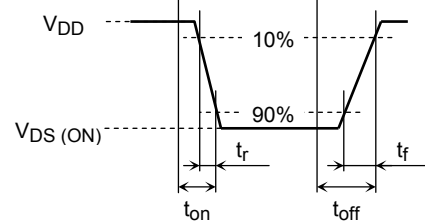


$V_{DD} = 3\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : t_r , $t_f < 5\text{ ns}$
 $(Z_{out} = 50\ \Omega)$
 Common Source
 $T_a = 25^\circ\text{C}$

(b) V_{IN}



(c) V_{OUT}

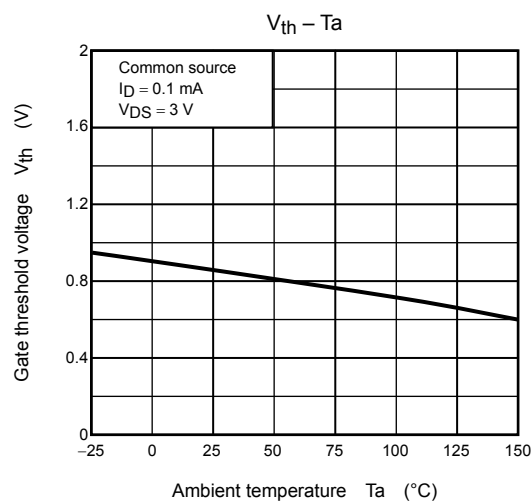
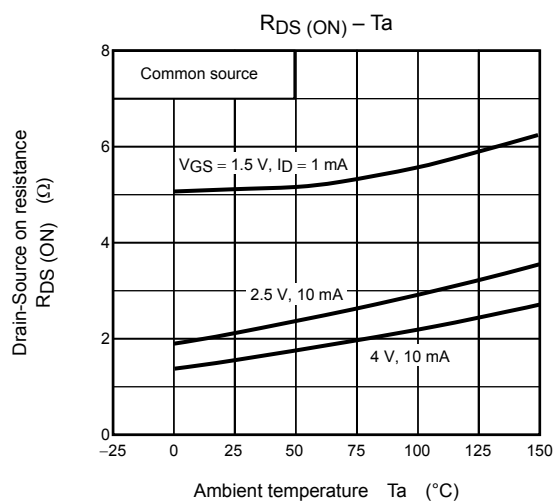
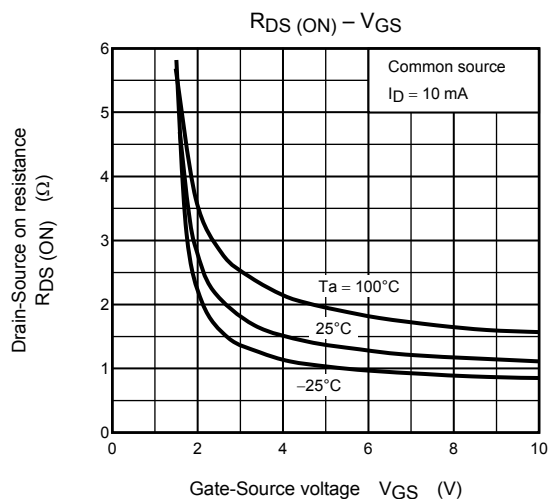
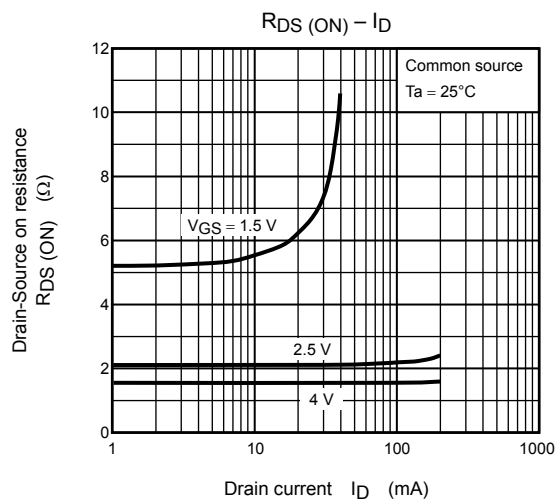
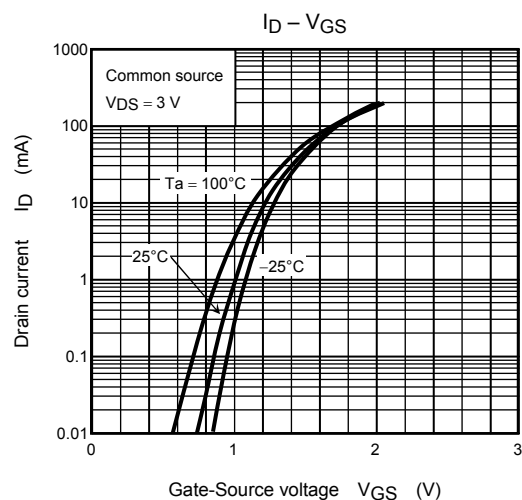
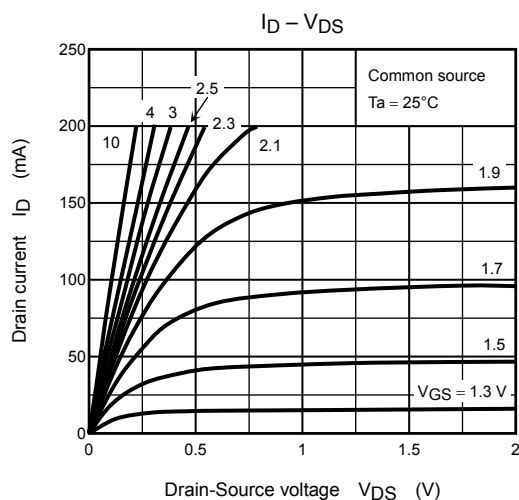


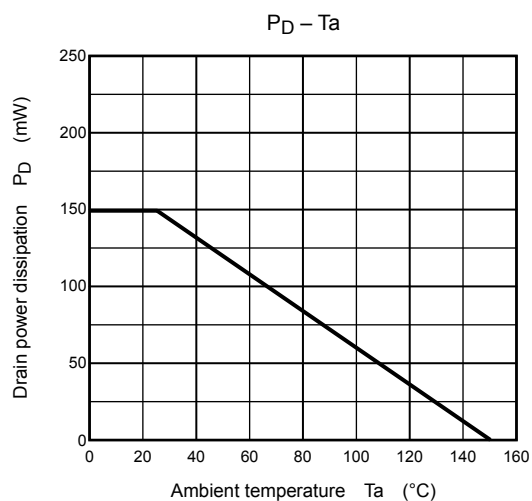
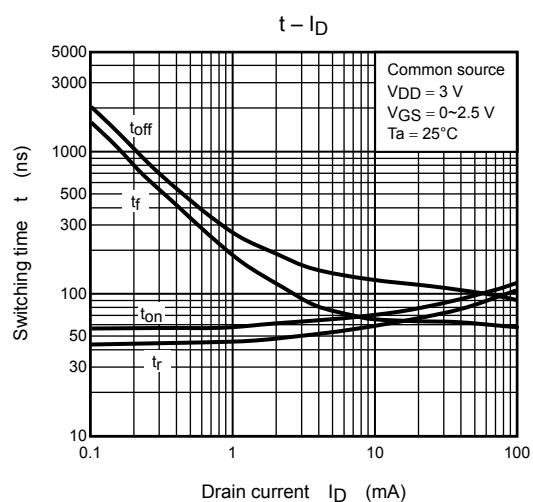
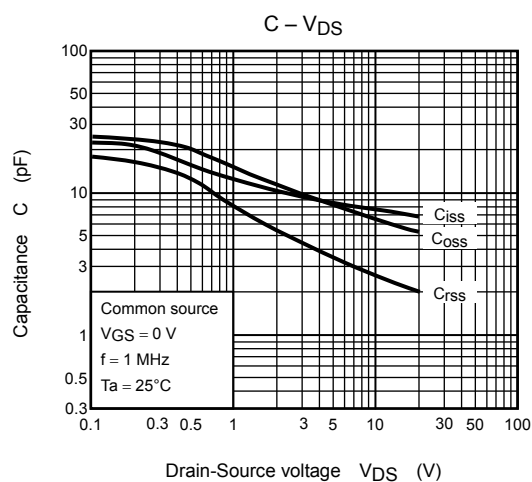
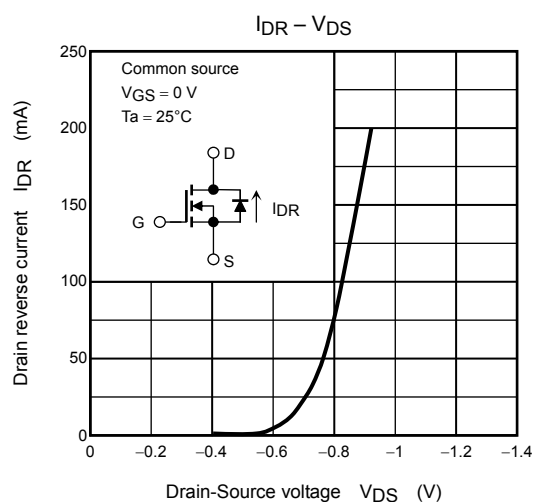
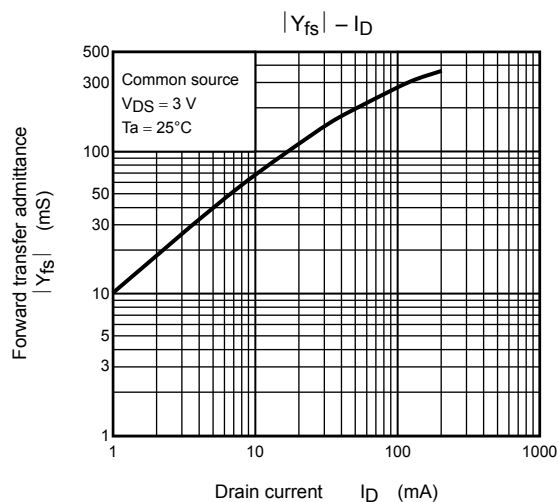
Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = 100\ \mu\text{A}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} .

(The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration when using the device.





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